



IR 1773 (2-2498)

THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of

Mark Pavier

Date: April 7, 2003

Serial No.: 09/718,932

Group Art Unit: 2812

Filed: November 22, 2000

Examiner: A. Roman

For: POWER SEMICONDUCTOR DIE ATTACH PROCESS USING
CONDUCTIVE ADHESIVE FILM

#1710
Ltr. w/aw 9/5
Am 2/8
J. McMillan
4/16/03

Asst. Commissioner for Patents
Washington, D.C. 20231

AMENDMENT/SUBMISSION

This is a response to the Office Action mailed November 8, 2002 in the above-identified application. Reconsideration of the application is respectfully requested.

FEE CALCULATION

Any additional fee required has been calculated as follows:

	NO. CLAIMS AFTER AMENDMENT		HIGHEST NO. PREVIOUSLY PAID FOR		EXTRA PRESENT		RATE	ADDIT. FEE
TOTAL	12	MINUS	20	* =	0	X	(\$9 SE or \$18)	\$
INDEP.	2	MINUS	3	** =	0	X	(\$42 SE or \$84)	\$
FIRST PRESENTATION OF MULTIPLE DEPENDENT CLAIM						X	(\$140 SE or \$280)	\$

* not less than 20 ** not less than 3

TOTAL \$ -0-

If any additional payment is required, a check which includes the calculated fee of \$ _____
(OFGS Check No. _____) is attached.

In the event the actual fee is greater than the payment submitted or is inadvertently not enclosed or if any additional fee during the prosecution of this application is not paid, the Patent Office is authorized to charge the underpayment to Deposit Account No. 15-0700.